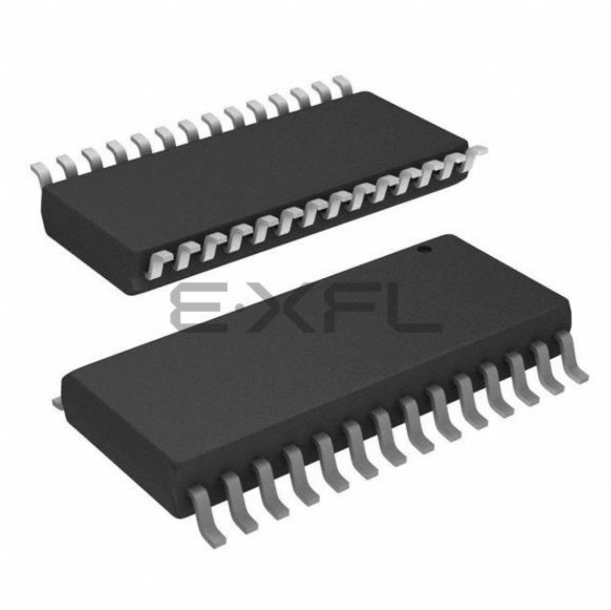

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	eZ8
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, LED, POR, PWM, WDT
Number of I/O	23
Program Memory Size	4KB (4K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f0430sj020sg

Block Diagram

Figure 1 displays a block diagram of the Z8 Encore! F0830 Series architecture.

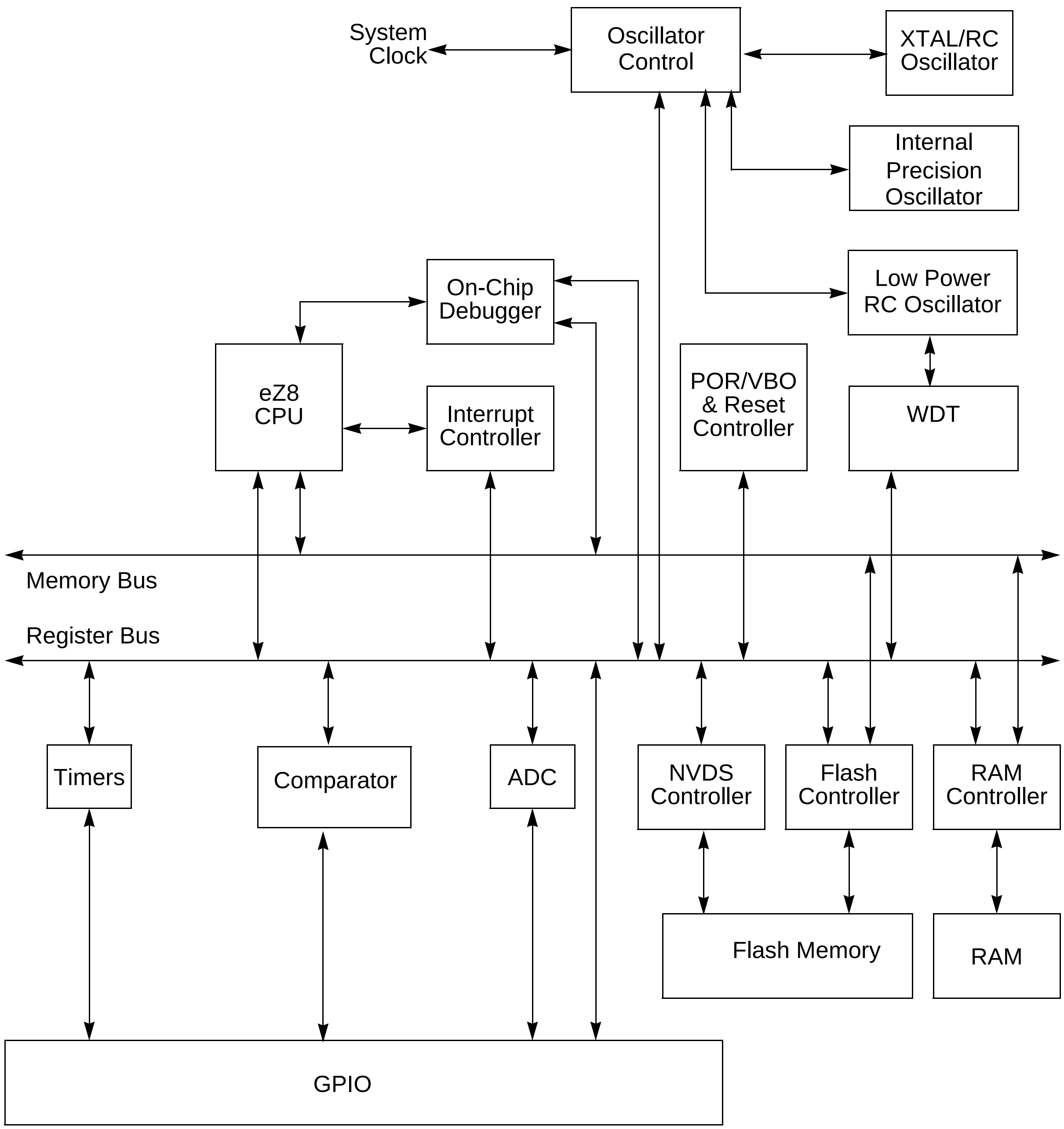

Figure 1. Z8 Encore! F0830 Series Block Diagram

Register Map

Table 8 provides an address map of the Z8 Encore! F0830 Series register file. Not all devices and package styles in the Z8 Encore! F0830 Series support the ADC or all of the GPIO ports. Consider registers for unimplemented peripherals as reserved.

Table 8. Register File Address Map

Address (Hex)	Register Description	Mnemonic	Reset (Hex)	Page No.
General Purpose RAM				
000–0FF	General purpose register file RAM	—	XX	
100–EFF	Reserved	—	XX	
Timer 0				
F00	Timer 0 high byte	T0H	00	83
F01	Timer 0 low byte	T0L	01	83
F02	Timer 0 reload high byte	T0RH	FF	85
F03	Timer 0 reload low byte	T0RL	FF	85
F04	Timer 0 PWM high byte	T0PWMH	00	86
F05	Timer 0 PWM low byte	T0PWML	00	86
F06	Timer 0 control 0	T0CTL0	00	87
F07	Timer 0 control 1	T0CTL1	00	88
Timer 1				
F08	Timer 1 high byte	T1H	00	83
F09	Timer 1 low byte	T1L	01	83
F0A	Timer 1 reload high byte	T1RH	FF	85
F0B	Timer 1 reload low byte	T1RL	FF	85
F0C	Timer 1 PWM high byte	T1PWMH	00	86
F0D	Timer 1 PWM low byte	T1PWML	00	86
F0E	Timer 1 control 0	T1CTL0	00	87
F0F	Timer 1 control 1	T1CTL1	00	83
F10–F6F	Reserved	—	XX	
Analog-to-Digital Converter (ADC)				
F70	ADC control 0	ADCCTL0	00	102
F71	Reserved	—	XX	
F72	ADC data high byte	ADCD_H	XX	103

Note: XX = Undefined.

Port A–D Address Registers

The Port A–D Address registers select the GPIO port functionality accessible through the Port A–D Control registers. The Port A–D Address and Control registers combine to provide access to all GPIO port controls; see Tables 18 and 19.

Table 18. Port A–D GPIO Address Registers (P*x*ADDR)

Bit	7	6	5	4	3	2	1	0
Field	PADDR[7:0]							
RESET	00H							
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FD0H, FD4H, FD8H, FDCH							

Bit	Description
[7:0] PADDR	**Port Address** The port address selects one of the subregisters accessible through the Port Control Register.

Table 19. Port Control Subregister Access

PADDR[7:0]	Port Control Subregister accessible using the Port A–D Control registers
00H	No function. Provides some protection against accidental port reconfiguration.
01H	Data Direction
02H	Alternate Function
03H	Output Control (open-drain)
04H	High Drive Enable
05H	Stop Mode Recovery Source Enable
06H	Pull-Up Enable
07H	Alternate Function Set 1
08H	Alternate Function Set 2
09H–FFH	No function

Interrupt Controller

The Interrupt Controller on the Z8 Encore!® F0830 Series products prioritize the interrupt requests from the on-chip peripherals and the GPIO port pins. The features of the Interrupt Controller include:

- Seventeen interrupt sources using sixteen unique interrupt vectors:
  - Twelve GPIO port pin interrupt sources
  - Five on-chip peripheral interrupt sources (Comparator Output interrupt shares one interrupt vector with PA6)
- Flexible GPIO interrupts
  - Eight selectable rising and falling edge GPIO interrupts
  - Four dual-edge interrupts
- Three levels of individually programmable interrupt priority
- Watchdog Timer can be configured to generate an interrupt
  m

Interrupt requests (IRQs) allow peripheral devices to suspend CPU operation in an orderly manner and force the CPU to start an interrupt service routine (ISR). Usually this interrupt service routine is involved with the exchange of data, status information or control information between the CPU and the interrupting peripheral. When the service routine is completed, the CPU returns to the operation from which it was interrupted.

The eZ8 CPU supports both vectored and polled interrupt handling. For polled interrupts, the Interrupt Controller has no effect on operation. For more information about interrupt servicing by the eZ8 CPU, refer to the eZ8 CPU User Manual (UM0128), which is available for download at www.zilog.com.

Interrupt Vector Listing

Table 34 lists the interrupts available in order of priority. The interrupt vector is stored with the most significant byte (MSB) at the even program memory address and the least significant byte (LSB) at the odd program memory address.

Note: Some port interrupts are not available on the 20-pin and 28-pin packages. The ADC interrupt is unavailable on devices not containing an ADC.

$$\text{PWM Period (s)} = \frac{\text{Reload Value} \times \text{Prescale}}{\text{System Clock Frequency (Hz)}}$$

If an initial starting value other than 0001H is loaded into the Timer High and Low Byte registers, use the ONE-SHOT Mode equation to determine the first PWM time-out period.

If TPOL bit is set to 0, the ratio of the PWM output high time to the total period is represented by:

$$\text{PWM Output High Time Ratio (\%)} = \frac{\text{Reload Value} - \text{PWM Value}}{\text{Reload Value}} \times 100$$

If TPOL bit is set to 1, the ratio of the PWM output high time to the total period is represented by:

$$\text{PWM Output High Time Ratio (\%)} = \frac{\text{PWM Value}}{\text{Reload Value}} \times 100$$

PWM DUAL OUTPUT Mode

In PWM DUAL OUTPUT Mode, the timer outputs a PWM output signal pair (basic PWM signal and its complement) through two GPIO port pins. The timer input is the system clock. The timer first counts up to 16-bit PWM match value stored in the timer PWM High and Low Byte registers. When the timer count value matches the PWM value, the timer output toggles. The timer continues counting until it reaches the reload value stored in the Timer Reload High and Low Byte registers. Upon reaching the reload value, the timer generates an interrupt, the count value in the Timer High and Low Byte registers is reset to 0001H and counting resumes.

If the TPOL bit in the Timer Control Register is set to 1, the timer output signal begins as a High (1) and transitions to a Low (0) when the timer value matches the PWM value. The timer output signal returns to a High (1) after the timer reaches the reload value and is reset to 0001H.

If the TPOL bit in the Timer Control Register is set to 0, the timer output signal begins as a Low (0) and transitions to a High (1) when the timer value matches the PWM value. The timer output signal returns to a Low (0) after the timer reaches the reload value and is reset to 0001H.

The timer also generates a second PWM output signal: the timer output complement. The timer output complement is the complement of the timer output PWM signal. A programmable deadband delay can be configured to time delay (0 to 128 system clock cycles) PWM output transitions on these two pins from a Low to a High (inactive to active) to ensure a time gap between the deassertion of one PWM output to the assertion of its complement.

Watchdog Timer Refresh

Upon first enable, the Watchdog Timer is loaded with the value in the Watchdog Timer Reload registers. The Watchdog Timer counts down to 000000H unless a WDT instruction is executed by the eZ8 CPU. Execution of the WDT instruction causes the downcounter to be reloaded with the WDT reload value stored in the Watchdog Timer Reload registers. Counting resumes following the Reload operation.

When the Z8 Encore! F0830 Series devices are operating in DEBUG Mode (using the On-Chip Debugger), the Watchdog Timer must be continuously refreshed to prevent any WDT time-outs.

Watchdog Timer Time-Out Response

The Watchdog Timer times out when the counter reaches 000000H. A time-out of the Watchdog Timer generates either an interrupt or a system reset. The WDT_RES Flash option bit determines the time-out response of the Watchdog Timer. See *the* Flash Option Bits chapter on page 124 for information about programming the WDT_RES Flash option bit.

WDT Interrupt in Normal Operation

If configured to generate an interrupt when a time-out occurs, the Watchdog Timer issues an interrupt request to the Interrupt Controller and sets the WDT status bit in the Reset Status Register. If interrupts are enabled, the eZ8 CPU responds to the interrupt request by fetching the Watchdog Timer interrupt vector and executing code from the vector address. After time-out and interrupt generation, the Watchdog Timer counter resets to its maximum value of FFFFFH and continues counting. The Watchdog Timer counter will not automatically return to its reload value.

The Reset Status Register (see Table 12 *on page 29*) must be read before clearing the WDT interrupt. This read clears the WDT time-out flag and prevents further WDT interrupts occurring immediately.

WDT Interrupt in STOP Mode

If configured to generate an interrupt when a time-out occurs and the Z8 Encore! F0830 Series devices are in STOP Mode, the Watchdog Timer automatically initiates a Stop Mode Recovery and generates an interrupt request. Both the WDT status bit and the STOP bit in the Watchdog Timer Control Register are set to 1 following a WDT time-out in STOP Mode. See *the* Reset and Stop Mode Recovery *chapter on page 21* for more information about Stop Mode Recovery operations.

If interrupts are enabled, following completion of the Stop Mode Recovery, the eZ8 CPU responds to the interrupt request by fetching the Watchdog Timer interrupt vector and executes the code from the vector address.

ADC Data High Byte Register

The ADC Data High Byte Register, listed in Table 64, contains the upper eight bits of the ADC output. Access to the ADC Data High Byte Register is read-only. Reading the ADC Data High Byte Register latches data in the ADC Low Bits Register.

Table 64. ADC Data High Byte Register (ADCD_H)

Bit	7	6	5	4	3	2	1	0
Field	ADCDH							
RESET	X							
R/W	R							
Address	F72H							

Bit	Description
[7:0] ADCDH	**ADC High Byte** 00h–FFh = The last conversion output is held in the data registers until the next ADC conversion is completed.

ADC Data Low Bits Register

The ADC Data Low Bits Register, shown in Table 65, contains the lower bits of the ADC output. Access to the ADC Data Low Bits Register is read-only. Reading the ADC Data High Byte Register latches lower bits of the ADC in the ADC Data Low Bits Register.

Table 65. ADC Data Low Bits Register (ADCD_L)

Bit	7	6	5	4	3	2	1	0
Field	ADCDL		Reserved					
RESET	X		X					
R/W	R		R					
Address	F73H							

Bit	Description
[7:6] ADCDL	**ADC Low Bits** 00–11b = These bits are the two least-significant bits of the 10-bit ADC output. These bits are undefined after a reset. The low bits are latched into this register whenever the ADC Data High Byte Register is read.
[5:0]	**Reserved** These bits are reserved and must be programmed to 000000.

Flash Frequency High and Low Byte Registers

The Flash Frequency High and Low Byte registers, shown in Tables 76 and 77, combine to form a 16-bit value, FFREQ, to control timing for Flash program and erase operations. The 16-bit binary Flash frequency value must contain the system clock frequency (in kHz) and is calculated using the following equation:

$$\text{FFREQ[15:0]} = \{\text{FFREQH[7:0],FFREQL[7:0]}\} = \frac{\text{System Clock Frequency}}{1000}$$

! **Caution:** Flash programming and erasure is not supported for system clock frequencies below 10kHz or above 20MHz. The Flash Frequency High and Low Byte registers must be loaded with the correct value to ensure proper operation of the device.

Table 76. Flash Frequency High Byte Register (FFREQH)

Bit	7	6	5	4	3	2	1	0
Field	FFREQH							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FFAH							

Bit	Description
[7:0] FFREQH	**Flash Frequency High Byte** High byte of the 16-bit Flash frequency value.

Table 77. Flash Frequency Low Byte Register (FFREQL)

Bit	7	6	5	4	3	2	1	0
Field	FFREQL							
RESET	0							
R/W	R/W							
Address	FFBH							

Bit	Description
[7:0] FFREQL	**Flash Frequency High Byte** Low byte of the 16-bit Flash frequency value.

Bit	Description (Continued)
[3] VBO_AO	**Voltage Brown-Out Protection Always On** 0 = Voltage Brown-Out protection is disabled in STOP Mode to reduce total power consumption. 1 = Voltage Brown-Out protection is always enabled, even during STOP Mode. This setting is the default setting for unprogrammed (erased) Flash.
[2] FRP	**Flash Read Protect** 0 = User program code is inaccessible. Limited control features are available through the On-Chip Debugger. 1 = User program code is accessible. All On-Chip Debugger commands are enabled. This is the default setting for unprogrammed (erased) Flash.
[1]	**Reserved** This bit is reserved and must be programmed to 1.
[0] FWP	**Flash Write Protect** This option bit provides Flash program memory protection. 0 = Programming and erasure disabled for all Flash program memory. Programming, page erase and mass erase through user code is disabled. Mass erase is available using the On-Chip Debugger. 1 = Programming, page erase and mass erase are enabled for all Flash program memory.

Table 82. Flash Options Bits at Program Memory Address 0001H

Bit	7	6	5	4	3	2	1	0
Field	VBO_RES	Reserved		XTLDIS	Reserved			
RESET	U	U	U	U	U	U	U	U
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	Program Memory 0001H							
Note: U = Unchanged by Reset. R/W = Read/Write.								

Bit	Description
[7] VBO_RES	**Voltage Brown-Out reset** 1 = VBO detection causes a system reset. This setting is the default setting for unprogrammed (erased) Flash.
[6:5]	**Reserved** These bits are reserved and must be programmed to 11.

Table 95. On-Chip Debugger Command Summary (Continued)

Debug Command	Command Byte	Enabled when not in DEBUG Mode?	Disabled by Flash Read Protect Option Bit
Read Program Memory CRC	0EH	–	–
Reserved	0FH	–	–
Step Instruction	10H	–	Disabled
Stuff Instruction	11H	–	Disabled
Execute Instruction	12H	–	Disabled
Reserved	13H–FFH	–	–

In the following bulleted list of OCD commands, data and commands sent from the host to the OCD are identified by `DBG ← Command/Data`. Data sent from the OCD back to the host is identified by `DBG Data`.

Read OCD Revision (00H). The read OCD revision command determines the version of the On-Chip Debugger. If OCD commands are added, removed or changed this revision number changes.

```
DBG ←00H
DBG → OCDRev[15:8] (Major revision number)
DBG → OCDRev[7:0] (Minor revision number)
```

Read OCD Status Register (02H). The read OCD Status Register command reads the OCDSTAT register.

```
DBG ← 02H
DBG → OCDSTAT[7:0]
```

Read Runtime Counter (03H). The runtime counter counts system clock cycles in between breakpoints. The 16-bit runtime counter counts from `0000H` and stops at the maximum count of `FFFFH`. The runtime counter is overwritten during the write memory, read memory, write register, read register, read memory CRC, step instruction, stuff instruction and execute instruction commands.

```
DBG ← 03H
DBG → RuntimeCounter[15:8]
DBG → RuntimeCounter[7:0]
```

Write OCD Control Register (04H). The write OCD Control Register command writes the data that follows to the OCDCTL register. When the Flash read protect option bit is enabled, the DBGMODE bit (`OCDCTL`[7]) can only be set to 1, it cannot be cleared to 0. To return the device to normal operating mode, the device must be reset.

```
DBG ← 04H
DBG ← OCDCTL[7:0]
```

Crystal Oscillator

The products in the Z8 Encore! F0830 Series contain an on-chip crystal oscillator for use with external crystals with 32kHz to 20MHz frequencies. In addition, the oscillator supports external RC networks with oscillation frequencies up to 4MHz or ceramic resonators with frequencies up to 8MHz. The on-chip crystal oscillator can be used to generate the primary system clock for the internal eZ8 CPU and the majority of its on-chip peripherals. Alternatively, the X_{IN} input pin can also accept a CMOS-level clock input signal (32kHz–20MHz). If an external clock generator is used, the X_{OUT} pin must remain unconnected. The on-chip crystal oscillator also contains a clock filter function. To see the settings for this clock filter, see Table 90 on page 133. By default, however, this clock filter is disabled; therefore, no divide to the input clock (namely, the frequency of the signal on the X_{IN} input pin) can determine the frequency of the system clock when using the default settings.

Note: Although the X_{IN} pin can be used as an input for an external clock generator, the CLKIN pin is better suited for such use. See *the* System Clock Selection *section on page 151* for more information.

Operating Modes

The Z8 Encore! F0830 Series products support the following four OSCILLATOR Modes:

- Minimum power for use with very low frequency crystals (32kHz to 1MHz)
- Medium power for use with medium frequency crystals or ceramic resonators (0.5MHz to 8MHz)
- Maximum power for use with high frequency crystals (8MHz to 20MHz)
- On-chip oscillator configured for use with external RC networks (<4MHz)

The OSCILLATOR Mode is selected using user-programmable Flash option bits. See the Flash Option Bits chapter on page 124 for more information.

Crystal Oscillator Operation

The XTLDIS Flash option bit controls whether the crystal oscillator is enabled during reset. The crystal may later be disabled after reset if a new oscillator has been selected as the system clock. If the crystal is manually enabled after reset through the OSCCTL Reg-

Table 105. Arithmetic Instructions (Continued)

Mnemonic	Operands	Instruction
INCW	dst	Increment Word
MULT	dst	Multiply
SBC	dst, src	Subtract with Carry
SBCX	dst, src	Subtract with Carry using Extended Addressing
SUB	dst, src	Subtract
SUBX	dst, src	Subtract using Extended Addressing

Table 106. Bit Manipulation Instructions

Mnemonic	Operands	Instruction
BCLR	bit, dst	Bit Clear
BIT	p, bit, dst	Bit Set or Clear
BSET	bit, dst	Bit Set
BSWAP	dst	Bit Swap
CCF	—	Complement Carry Flag
RCF	—	Reset Carry Flag
SCF	—	Set Carry Flag
TCM	dst, src	Test Complement Under Mask
TCMX	dst, src	Test Complement Under Mask using Extended Addressing
TM	dst, src	Test Under Mask
TMX	dst, src	Test Under Mask using Extended Addressing

Table 107. Block Transfer Instructions

Mnemonic	Operands	Instruction
LDCI	dst, src	Load Constant to/from Program Memory and Auto-Increment Addresses
LDEI	dst, src	Load External Data to/from Data Memory and Auto-Increment Addresses

Op Code Maps

A description of the opcode map data and the abbreviations are provided in Figure 28. Table 114 on page 181 lists opcode map abbreviations.

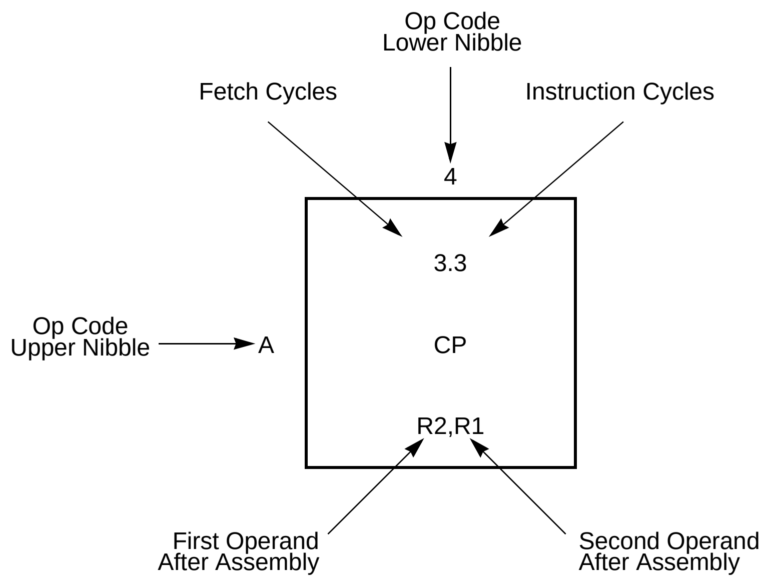

Figure 28. Op Code Map Cell Description

Table 121. Nonvolatile Data Storage

	V_{DD} = 2.7 to 3.6V T_A = 0°C to +70°C			V_{DD} = 2.7 to 3.6V T_A = –40°C to +105°C				
Parameter	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Units**	**Notes**
NVDS Byte Read Time				71	–	258	µs	With system clock at 20MHz
NVDS Byte Program Time				126	–	136	µs	With system clock at 20MHz
Data Retention				10	–	–	years	25°C
Endurance				100,000	–	–	cycles	Cumulative write cycles for entire memory

Note: For every 200 writes, a maintenance operation is necessary. In this rare occurrence, the write can take up to 58ms to complete.

Table 122. Analog-to-Digital Converter Electrical Characteristics and Timing

		V_{DD} = 2.7 to 3.6V T_A = 0°C to +70°C			V_{DD} = 2.7 to 3.6V T_A = –40°C to +105°C				
Symbol	**Parameter**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Units**	**Conditions**
	Resolution				–	10	–	bits	
	Differential Nonlinearity (DNL) [1]				–1	–	+4	LSB	
	Integral Nonlinearity (INL) [1]				–5	–	+5	LSB	
	Gain Error					15		LSB	
	Offset Error				–15	–	15	LSB	PDIP package
					–9	–	9	LSB	Other packages
V_{REF}	On chip reference				1.9	2.0	2.1	V	
	Active Power Consumption					4		mA	
	Power Down Current						1	µA	

Note: [1]When the input voltage is lower than 20mV, the conversion error is out of spec.

General Purpose I/O Port Input Data Sample Timing

Figure 33 displays timing of the GPIO port input sampling. The input value on a GPIO port pin is sampled on the rising edge of the system clock. The port value is available to the eZ8 CPU on the second rising clock edge following the change of the port value.

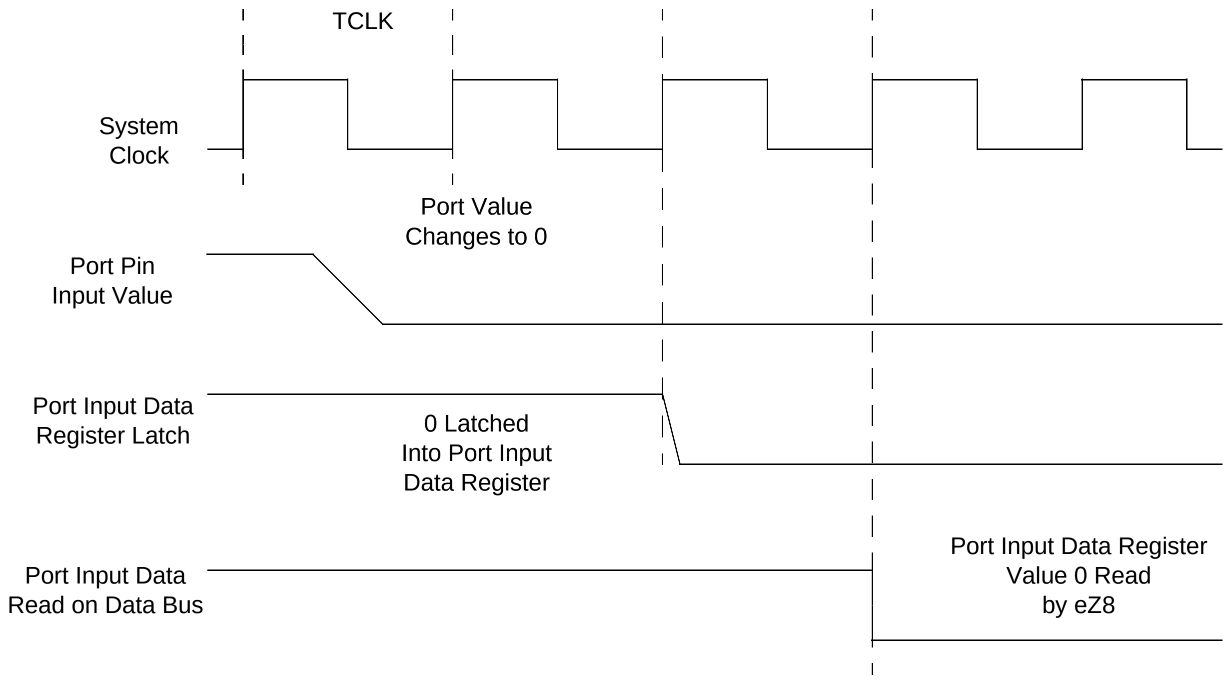

Figure 33. Port Input Sample Timing

Table 124. GPIO Port Input Timing

Parameter	Abbreviation	Delay (ns)	
		Minimum	Maximum
T_{S_PORT}	Port Input Transition to X_{IN} Rise Setup Time (not pictured)	5	–
T_{H_PORT}	X_{IN} Rise to Port Input Transition Hold Time (not pictured)	0	–
T_{SMR}	GPIO port pin pulse width to ensure Stop Mode Recovery (for GPIO port pins enabled as SMR sources)	1 µs	

Hex Address: F83

Table 153. LED Drive Level High Register (LEDLVLH)

Bit	7	6	5	4	3	2	1	0
Field	LEDLVLH[7:0]							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F83H							

Hex Address: F84

Table 154. LED Drive Level Low Register (LEDLVLL)

Bit	7	6	5	4	3	2	1	0
Field	LEDLVLL[7:0]							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F84H							

Hex Address: F85

This address range is reserved.

Oscillator Control

For more information about the Oscillator Control registers, see the Oscillator Control Register Definitions section on page 154.

Hex Address: F86

Table 155. Oscillator Control Register (OSCCTL)

Bit	7	6	5	4	3	2	1	0
Field	INTEN	XTLEN	WDTEN	POFEN	WDFEN	SCKSEL		
RESET	1	0	1	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F86H							

Hex Address: FFB

Table 196. Flash Frequency Low Byte Register (FFREQL)

Bit	7	6	5	4	3	2	1	0
Field	FFREQL							
RESET	0							
R/W	R/W							
Address	FFBH							

P

R

S

T